



Material Content Data Sheet



Halogen-Free

Sales Product Name	SPA11N80C3	Issued	24. June 2021
MA#	MA005550467		
Package	PG-TO220-3-317	Weight*	2103.47 mg

Construction Element	Material Group	Substances	CAS# if applicable	Weight [mg]	Average Mass [%]	Sum [%]	Average Mass [ppm]	Sum [ppm]
chip	inorganic material	silicon	7440-21-3	9.366	0.45	0.45	4453	4453
leadframe	inorganic material	phosphorus	7723-14-0	0.361	0.02		171	
	non noble metal	iron	7439-89-6	1.202	0.06		572	
	non noble metal	copper	7440-50-8	1,200.685	57.07	57.15	570811	571554
wire	non noble metal	aluminium	7429-90-5	3.651	0.17	0.17	1736	1736
encapsulation	organic material	carbon black	1333-86-4	8.640	0.41		4107	
	plastics	epoxy resin	-	141.577	6.73		67306	
	inorganic material	silicondioxide	60676-86-0	725.687	34.50	41.64	344994	416407
leadfinish	non noble metal	tin	7440-31-5	7.889	0.38	0.38	3750	3750
solder	non noble metal	antimony	7440-36-0	0.442	0.02		210	
	noble metal	silver	7440-22-4	1.104	0.05		525	
	non noble metal	tin	7440-31-5	2.870	0.14	0.21	1365	2100
*deviation	< 10%	Sum in total:				100.00		1000000

Important Remarks:

1. Infineon Technologies AG provides full material declaration based on information provided by third parties and has taken and continues to take reasonable steps to provide representative and accurate information.
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3. All statements are based on our present knowledge, are provided 'as is' and may be subject to change at any time due to technical requirements and development without notification.

This product is in compliance with EU Directive 2015/863/EU amending Annex II to EU Directive 2011/65/EU (RoHS) and does not use any exemption.

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